

## PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Srikanth Narasimalu</td><td>03/08/2008</td></tr><tr><td>Sathish Kumar Balakrishnan</td><td>03/19/2008</td></tr><tr><td>Ning Ying</td><td>03/19/2008</td></tr><tr><td>Shu Chuen Ho</td><td>03/19/2008</td></tr></tbody></table>	Name	Execution Date	Srikanth Narasimalu	03/08/2008	Sathish Kumar Balakrishnan	03/19/2008	Ning Ying	03/19/2008	Shu Chuen Ho	03/19/2008	
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Ning Ying	03/19/2008										
Shu Chuen Ho	03/19/2008										
RECEIVING PARTY DATA											
Name:	ASM Technology Singapore Pte Ltd.										
Street Address:	2 Yishun Avenue 7										
City:	Singapore										
State/Country:	SINGAPORE										
Postal Code:	768924										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12041140</td></tr></tbody></table>	Property Type	Number	Application Number:	12041140							
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Application Number:	12041140										
CORRESPONDENCE DATA											
Fax Number:	(212)382-0888										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
Phone:	2123820700										
Email:	dguido@ostrolenk.com										
Correspondent Name:	Ostrolenk, Faber, Gerb & Soffen, LLP										
Address Line 1:	1180 Avenue Of The Americas										
Address Line 4:	New York, NEW YORK 10036										
ATTORNEY DOCKET NUMBER:	P/4076-182 (V7846)										
NAME OF SUBMITTER:	Robert C. Faber										
Total Attachments: 1 source=00929586#page1.tif											

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PATENT

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PATENT APPLICATION ASSIGNMENT -  
SOLE AND JOINT INVENTORS  
EXECUTED OUTSIDE USA

OFGS FILE NO. \_\_\_\_\_

WHEREAS, I (We), Srikanth NARASIMALU, Sathish Kumar BALAKRISHNAN, Ning YING and Shu Chuen HO as assignor(s), have invented certain improvements in Molding Apparatus Incorporating Pressure Uniformity Adjustment for which an application for United States Letters Patent has been executed by me (us) of even date herewith; and

WHEREAS, ASM Technology Singapore Pte Ltd, a corporation organized and existing under the laws of Singapore and having a principal place of business at 2 Yishun Avenue 7, Singapore 768924 as assignee, is desirous of acquiring all right, title and interest in and to said invention and any Patent that may be granted therefor.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, I (We), as assignor(s), hereby sell, assign and set over to said assignee the entire right, title and interest for the United States and all other countries in and to said invention and the aforesaid application for Patent, all original, divisional, continuation, substitute or reissue applications and patents applied for or granted therefor in the United States and all other countries, including all rights of priority from the filing of said application, and all rights for past infringement, and the Commissioner of Patents and Trademarks is hereby authorized and requested to issue all patents on said inventions or resulting therefrom to said assignee herein, as assignee of the entire interest therein; and the undersigned for myself (ourselves) and my (our) legal representatives, heirs and assigns do hereby agree and covenant without further remuneration, to execute and deliver all divisional, continuation, reissue and other applications for Patent on said inventions and all assignments thereof to said assignee or its assigns, to communicate to said assignee or its representatives all facts known to the undersigned respecting said inventions, whenever requested, to testify in any interferences or other legal proceedings in which any of said applications or patents may become involved, to sign all lawful papers, make all rightful oaths, and to do generally everything necessary to assist assignee, its successors, assigns and nominees to obtain patent protection for said invention in the United States and all other countries, the expenses incident to said applications to be borne and paid by said assignee.

Date: 8/3/2008

N. Srikanth  
Srikanth NARASIMALU

Date: 19/3/2008

B. Sathish Kumar  
Sathish Kumar BALAKRISHNAN

Date: 19/3/2008

Ning YING  
Ning YING

Date: 19/3/2008

Shu Chuen HO  
Shu Chuen HO